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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	8064
Number of Logic Elements/Cells	-
Total RAM Bits	73728
Number of I/O	115
Number of Gates	500000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-55°C ~ 125°C (TA)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/ax500-pq208m

2 – Detailed Specifications

Operating Conditions

Table 2-1 lists the absolute maximum ratings of Axcelerator devices. Stresses beyond the ratings may cause permanent damage to the device. Exposure to Absolute Maximum rated conditions for extended periods may affect device reliability. Devices should not be operated outside the recommendations in Table 2-2.

Table 2-1 • **Absolute Maximum Ratings**

Symbol	Parameter	Limits	Units
VCCA	DC Core Supply Voltage	–0.3 to 1.7	V
VCCI	DC I/O Supply Voltage	–0.3 to 3.75	V
VREF	DC I/O Reference Voltage	–0.3 to 3.75	V
VI	Input Voltage	–0.5 to 4.1	V
VO	Output Voltage	–0.5 to 3.75	V
TSTG	Storage Temperature	–60 to +150	°C
VCCDA*	Supply Voltage for Differential I/Os	–0.3 to 3.75	V

*Note: * Should be the maximum of all VCCI.*

Table 2-2 • **Recommended Operating Conditions**

Parameter Range	Commercial	Industrial	Military	Units
Ambient Temperature (T_A)[1]	0 to +70	–40 to +85	–55 to +125	°C
1.5 V Core Supply Voltage	1.425 to 1.575	1.425 to 1.575	1.425 to 1.575	V
1.5 V I/O Supply Voltage	1.425 to 1.575	1.425 to 1.575	1.425 to 1.575	V
1.8 V I/O Supply Voltage	1.71 to 1.89	1.71 to 1.89	1.71 to 1.89	V
2.5 V I/O Supply Voltage	2.375 to 2.625	2.375 to 2.625	2.375 to 2.625	V
3.3 V I/O Supply Voltage	3.0 to 3.6	3.0 to 3.6	3.0 to 3.6	V
VCCDA Supply Voltage	3.0 to 3.6	3.0 to 3.6	3.0 to 3.6	V
VPUMP Supply Voltage	3.0 to 3.6	3.0 to 3.6	3.0 to 3.6	V

Notes:

1. *Ambient temperature (T_A) is used for commercial and industrial grades; case temperature (T_C) is used for military grades.*
2. *T_J max = 125°C*

Power-Up/Down Sequence

All Axcelerator I/Os are tristated during power-up until normal device operating conditions are reached, when I/Os enter user mode. VCCDA should be powered up before (or coincidentally with) VCCA and VCCI to ensure the behavior of user I/Os at system start-up. Conversely, VCCDA should be powered down after (or coincidentally with) VCCA and VCCI. Note that VCCI and VCCA can be powered up in any sequence with respect to each other, provided the requirement with respect to VCCDA is satisfied.

Table 2-4 • **Default CLOAD/VCCI**

	C_{LOAD} (pF)	VCCI (V)	PLOAD (mw/MHz)	P10 (mw/MHz)	PI/O (mW/MHz)*
Single-Ended without VREF					
LVTTL 24 mA High Slew	35	3.3	381.2	267.5	648.7
LVTTL 16 mA High Slew	35	3.3	381.2	225.1	606.3
LVTTL 12 mA High Slew	35	3.3	381.2	165.9	547.1
LVTTL 8 mA High Slew	35	3.3	381.2	130.3	511.5
LVTTL 24 mA Low Slew	35	3.3	381.2	169.2	550.4
LVTTL 16 mA Low Slew	35	3.3	381.2	150.8	532.0
LVTTL 12 mA Low Slew	35	3.3	381.2	138.6	519.8
LVTTL 8 mA Low Slew	35	3.3	381.2	118.7	499.9
LVCMOS – 25	35	2.5	218.8	148.0	366.8
LVCMOS – 18	35	1.8	113.4	73.4	186.8
LVCMOS – 15 (JESD8-11)	35	1.5	78.8	49.5	128.3
PCI	10	3.3	108.9	218.5	327.4
PCI-X	10	3.3	108.9	162.9	271.8
Single-Ended with VREF					
HSTL-I	20	1.5	–	40.9	40.9
SSTL2-I	30	2.5	–	171.2	171.2
SSTL2-II	30	2.5	–	147.8	147.8
SSTL3-I	30	3.3	–	327.2	327.2
SSTL3-II	30	3.3	–	288.4	288.4
GTLP – 25	10	2.5	–	61.5	61.5
GTLP – 33	10	3.3	–	68.5	68.5
Differential					
LVPECL – 33	N/A	3.3	–	260.6	260.6
LVDS – 25	N/A	2.5	–	145.8	145.8

Note: $*P_{I/O} = P10 + C_{LOAD} * VCC_I^2$

User-Defined Supply Pins

VREF **Supply Voltage**

Reference voltage for I/O banks. VREF pins are configured by the user from regular I/O pins; VREF pins are not in fixed locations. There can be one or more VREF pins in an I/O bank.

Global Pins

HCLKA/B/C/D **Dedicated (Hardwired) Clocks A, B, C and D**

These pins are the clock inputs for sequential modules or north PLLs. Input levels are compatible with all supported I/O standards. There is a P/N pin pair for support of differential I/O standards. Single-ended clock I/Os can only be assigned to the P side of a paired I/O. This input is directly wired to each R-cell and offers clock speeds independent of the number of R-cells being driven. When the HCLK pins are unused, it is recommended that they are tied to ground.

CLKE/F/G/H **Routed Clocks E, F, G, and H**

These pins are clock inputs for clock distribution networks or south PLLs. Input levels are compatible with all supported I/O standards. There is a P/N pin pair for support of differential I/O standards. Single-ended clock I/Os can only be assigned to the P side of a paired I/O. The clock input is buffered prior to clocking the R-cells. When the CLK pins are unused, Microsemi recommends that they are tied to ground.

JTAG/Probe Pins

PRA/B/C/D **Probe A, B, C and D**

The Probe pins are used to output data from any user-defined design node within the device (controlled with Silicon Explorer II). These independent diagnostic pins can be used to allow real-time diagnostic output of any signal path within the device. The pins' probe capabilities can be permanently disabled to protect programmed design confidentiality. The probe pins are of LVTTL output levels.

TCK **Test Clock**

Test clock input for JTAG boundary-scan testing and diagnostic probe (Silicon Explorer II).

TDI **Test Data Input**

Serial input for JTAG boundary-scan testing and diagnostic probe. TDI is equipped with an internal 10 kΩ pull-up resistor.

TDO **Test Data Output**

Serial output for JTAG boundary-scan testing.

TMS **Test Mode Select**

The TMS pin controls the use of the IEEE 1149.1 boundary-scan pins (TCK, TDI, TDO, TRST). TMS is equipped with an internal 10 kΩ pull-up resistor.

TRST **Boundary Scan Reset Pin**

The TRST pin functions as an active-low input to asynchronously initialize or reset the boundary scan circuit. The TRST pin is equipped with a 10 kΩ pull-up resistor.

Special Functions

LP **Low Power Pin**

The LP pin controls the low power mode of Axcelerator devices. The device is placed in the low power mode by connecting the LP pin to logic high. To exit the low power mode, the LP pin must be set Low. Additionally, the LP pin must be set Low during chip powering-up or chip powering-down operations. See "Low Power Mode" on page 2-106 for more details.

NC **No Connection**

This pin is not connected to circuitry within the device. These pins can be driven to any voltage or can be left floating with no effect on the operation of the device.

***Table 2-22* • 3.3 V LVTTL I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C (continued)

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
LVTTL Output Drive Strength = 2 (12 mA) / High Slew Rate								
t_{DP}	Input Buffer		1.68		1.92		2.26	ns
t_{PY}	Output Buffer		3.30		3.76		4.42	ns
t_{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		3.74		4.26		5.00	ns
t_{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		3.06		3.49		4.10	ns
t_{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		1.89		1.91		1.91	ns
t_{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		2.29		2.30		2.31	ns
t_{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t_{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

1.5 V LVCMOS (JESD8-11)

Low-Voltage Complementary Metal-Oxide Semiconductor for 1.5 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 1.5 V applications. It uses a 3.3 V tolerant CMOS input buffer and a push-pull output buffer.

***Table 2-29* • DC Input and Output Levels**

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	**Max., V**	**Min., V**	**Max., V**	**Max., V**	**Min., V**	**mA**	**mA**
–0.3	0.35 VCCI	0.65 VCCI	3.6	0.4	VCCI – 0.4	8 mA	–8 mA

AC Loadings

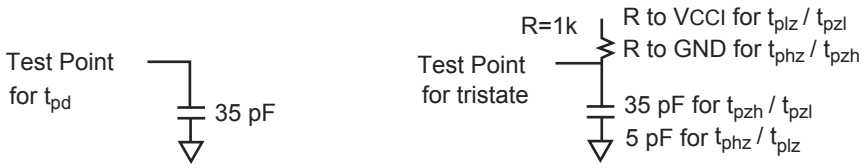

***Table 2-30* • AC Test Loads**

***Table 2-31* • AC Waveforms, Measuring Points, and Capacitive Loads**

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C_{load} (pF)
0	1.5	$0.5V_{CCI}$	N/A	35

*Note: * Measuring Point = VTRIP*

Timing Characteristics

***Table 2-61* • LVPECL I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
LVPECL Output Module Timing								
t_{DP}	Input Buffer		1.66		1.89		2.22	ns
t_{PY}	Output Buffer		2.24		2.55		3.00	ns
t_{ICLKQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t_{OCLKQ}	Clock-to-Q for the IO output register and the I/O enable register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Carry-Chain Logic

The Axcelerator dedicated carry-chain logic offers a very compact solution for implementing arithmetic functions without sacrificing performance.

To implement the carry-chain logic, two C-cells in a Cluster are connected together so the FCO (i.e. carry out) for the two bits is generated in a carry look-ahead scheme to achieve minimum propagation delay from the FCI (i.e. carry in) into the two-bit Cluster. The two-bit carry logic is shown in Figure 2-29.

The FCI of one C-cell pair is driven by the FCO of the C-cell pair immediately above it. Similarly, the FCO of one C-cell pair, drives the FCI input of the C-cell pair immediately below it (Figure 1-4 on page 1-3 and Figure 2-30 on page 2-57).

The carry-chain logic is selected via the CFN input. When carry logic is not required, this signal is deasserted to save power. Again, this configuration is handled automatically for the user through Microsemi's macro library.

The signal propagation delay between two C-cells in the carry-chain sequence is 0.1 ns.

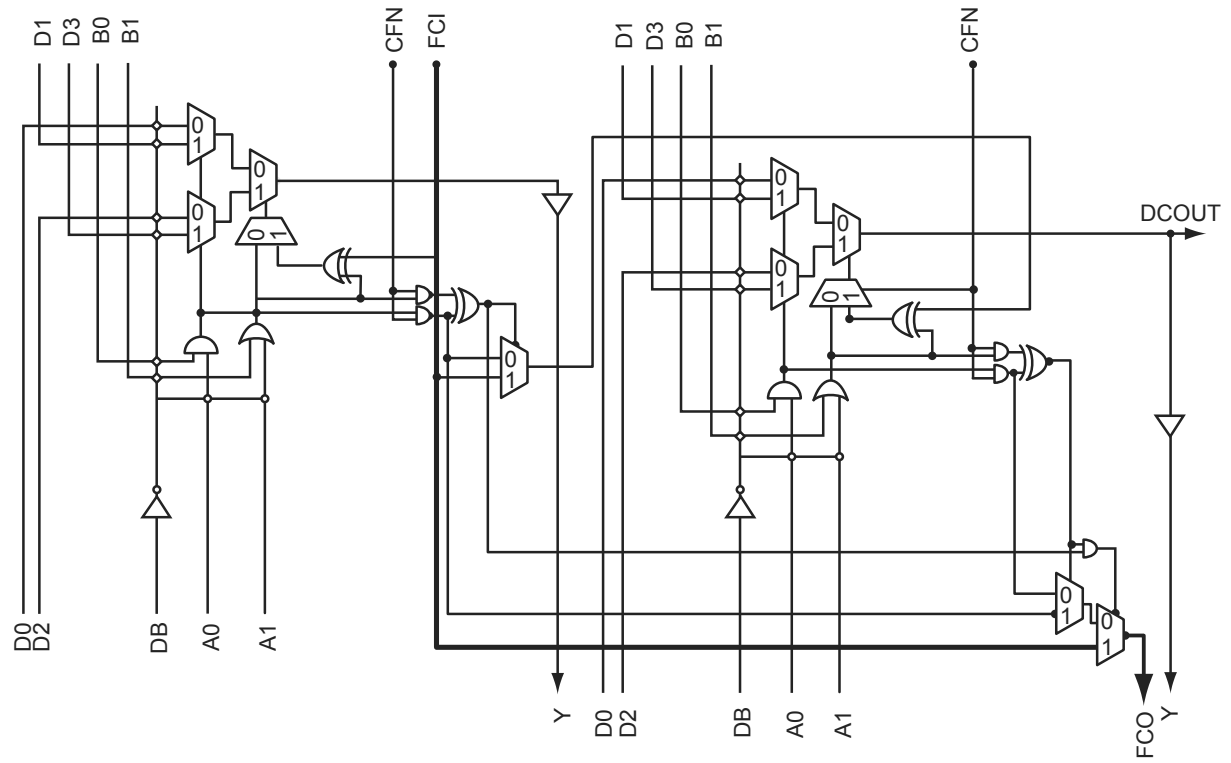

Figure 2-29 • **Axcelerator's Two-Bit Carry Logic**

***Table 2-80* • PLL Interface Signals**

Signal Name	Type	User Accessible	Allowable Values	Function
RefCLK	Input	Yes		Reference Clock for the PLL
FB	Input	Yes		Feedback port for the PLL
PowerDown	Input	Yes		PLL power down control
			0	PLL powered down
			1	PLL active
DIVI[5:0]	Input	Yes	1 to 64, in unsigned binary notation offset by -1	Sets value for feedback divider (multiplier)
DIVJ[5:0]	Input	Yes		Sets value for CLK1 divider
LowFreq	Input	Yes		Input frequency range selector
			0	50–200 MHz
			1	14–50 MHz
Osc[2:0]	Input	Yes		Output frequency range selector
			XX0	400–1000 MHZ
			001	200–400 MHZ
			011	100–200 MHZ
			101	50–100 MHZ
			111	20–50 MHZ
DelayLine[4:0]	Input	Yes	–15 to +15 (increments), in signed-and-magnitude binary representation	Clock Delay (positive/negative) in increments of 250 ps, with maximum value of ± 3.75 ns
FBMuxSel	Input	No		Selects the source for the feedback input
REFSEL	Input	No		Selects the source for the reference clock
OUTSEL	Input	No		Selects the source for the routed net output
PLLSEL	Input	No		ROOTSEL & PLLSEL are used to select the source of the global clock network
ROOTSEL	Input	No		
Lock	Output	Yes		High value indicates PLL has locked
CLK1	Output	Yes		PLL clock output
CLK2	Output	Yes		PLL clock output

Note: If the input RefClk is taken outside its operating range, the outputs Lock, CLK1 and CLK2 are indeterminate.

FIFO

Every memory block has its own embedded FIFO controller. Each FIFO block has one read port and one write port. This embedded FIFO controller uses no internal FPGA logic and features:

- Glitch-free FIFO Flags
- Gray-code address counters/pointers to prevent metastability problems
- Overflow and underflow control

Both ports are configurable in various sizes from 4k x 1 to 128 x 36, similar to the RAM block size. Each port is fully synchronous.

Read and write operations can be completely independent. Data on the appropriate WD pins are written to the FIFO on every active WCLK edge as long as WEN is high. Data is read from the FIFO and output on the appropriate RD pins on every active RCLK edge as long as REN is asserted.

The FIFO block offers programmable almost-empty (AEMPTY) and almost-full (AFULL) flags as well as EMPTY and FULL flags (Figure 2-61):

- The FULL flag is synchronous to WCLK. It allows the FIFO to inhibit writing when full.
- The EMPTY flag is synchronous to RCLK. It allows the FIFO to inhibit reading at the empty condition.

Gray code counters are used to prevent metastability problems associated with flag logic. The depth of the FIFO is dependent on the data width and the number of memory blocks used to create the FIFO. The write operations to the FIFO are synchronous with respect to the WCLK, and the read operations are synchronous with respect to the RCLK.

The FIFO block may be reset to the empty state.

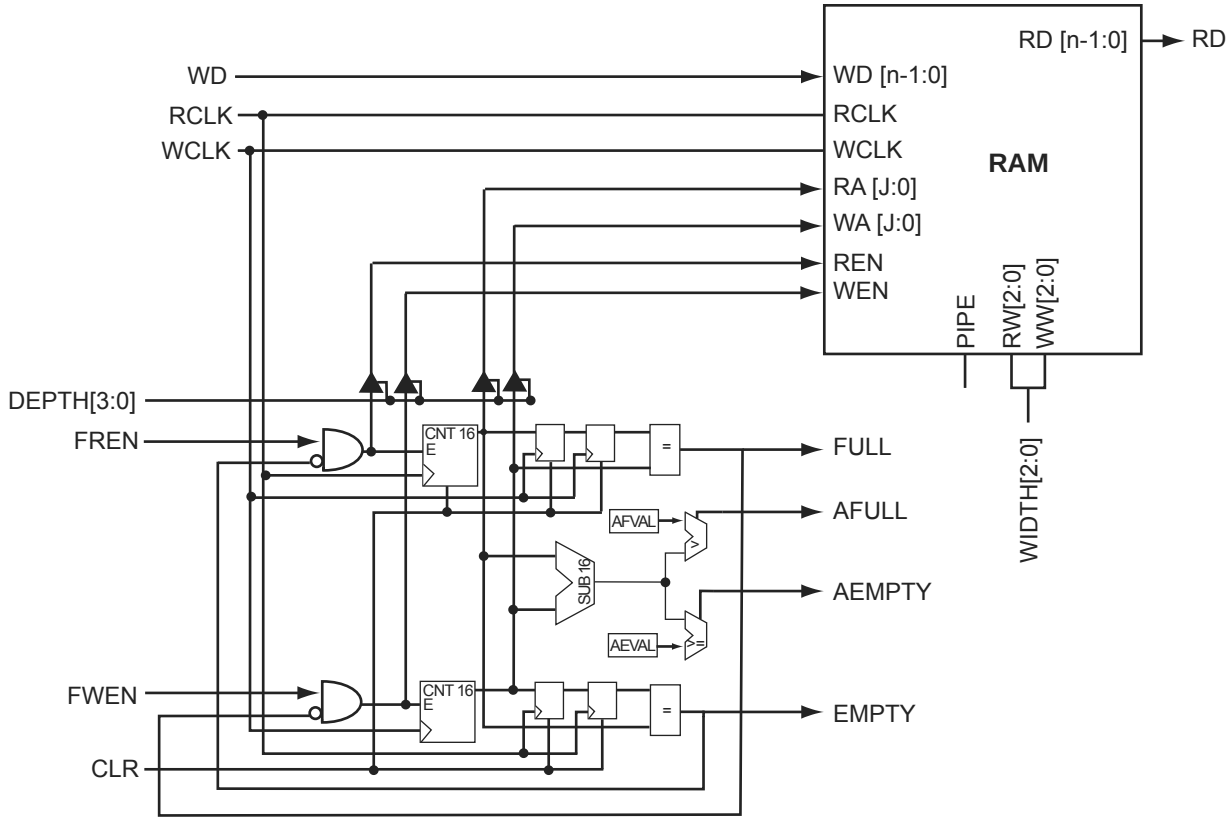

Figure 2-61 • **Axcelerator RAM with Embedded FIFO Controller**

BG729	
AX1000 Function	Pin Number
IO218PB6F20	V2
IO219NB6F20	T1
IO219PB6F20	U1
IO220NB6F20	R5
IO220PB6F20	R6
IO221NB6F20	T3
IO221PB6F20	T4
IO222NB6F20	R2
IO222PB6F20	T2
IO223NB6F20	P8
IO223PB6F20	P9
IO224NB6F20	R3
IO224PB6F20	R4
Bank 7	
IO225NB7F21	P1
IO225PB7F21	R1
IO226NB7F21	P3
IO226PB7F21	P2
IO227NB7F21	N7
IO227PB7F21	P7
IO228NB7F21	P5
IO228PB7F21	P4
IO229NB7F21	N2
IO229PB7F21	N1
IO230NB7F21	N6
IO230PB7F21	P6
IO231NB7F21	N9
IO231PB7F21	N8
IO232NB7F21	N4
IO232PB7F21	N3
IO233NB7F21	M2
IO233PB7F21	M1
IO234NB7F21	M4
IO234PB7F21	M3
IO235NB7F21	M5
IO235PB7F21	N5
IO236NB7F22	L2

BG729	
AX1000 Function	Pin Number
IO236PB7F22	L1
IO237NB7F22	L4
IO237PB7F22	L3
IO238NB7F22	L6
IO238PB7F22	M6
IO239NB7F22	M8
IO239PB7F22	M7
IO240NB7F22	K2
IO240PB7F22	K1
IO241NB7F22	K4
IO241PB7F22	K3
IO242NB7F22	K5
IO242PB7F22	L5
IO243NB7F22	J2
IO243PB7F22	J1
IO244NB7F22	J4
IO244PB7F22	J3
IO245NB7F22	H2
IO245PB7F22	H1
IO246NB7F22	H4
IO246PB7F22	H3
IO247NB7F23	L8
IO247PB7F23	L7
IO248NB7F23	J6
IO248PB7F23	K6
IO249NB7F23	H5
IO249PB7F23	J5
IO250NB7F23	G2
IO250PB7F23	G1
IO251NB7F23	K8
IO251PB7F23	K7
IO252NB7F23	G4
IO252PB7F23	G3
IO253NB7F23	F2
IO253PB7F23	F1
IO254NB7F23	G6
IO254PB7F23	H6

BG729	
AX1000 Function	Pin Number
IO255NB7F23	F5
IO255PB7F23	G5
IO256NB7F23	F3
IO256PB7F23	F4
IO257NB7F23	H7
IO257PB7F23	J7
Dedicated I/O	
GND	A1
GND	A2
GND	A25
GND	A26
GND	A27
GND	A3
GND	AC24
GND	AE1
GND	AE2
GND	AE25
GND	AE26
GND	AE27
GND	AE3
GND	AE5
GND	AF1
GND	AF2
GND	AF25
GND	AF26
GND	AF27
GND	AF3
GND	AG1
GND	AG2
GND	AG25
GND	AG26
GND	AG27
GND	AG3
GND	B1
GND	B2
GND	B25
GND	B26

FG256-Pin FBGA	
AX125 Function	**Pin Number**
Bank 0	
IO01NB0F0	B4
IO01PB0F0	B3
IO03NB0F0	A4
IO03PB0F0	A3
IO04NB0F0	B6
IO04PB0F0	B5
IO06NB0F0	A6
IO06PB0F0	A5
IO07NB0F0/HCLKAN	B8
IO07PB0F0/HCLKAP	B7
IO08NB0F0/HCLKBN	A9
IO08PB0F0/HCLKBP	A8
Bank 1	
IO09NB1F1/HCLKCN	C10
IO09PB1F1/HCLKCP	C9
IO10NB1F1/HCLKDN	B11
IO10PB1F1/HCLKDP	B10
IO12NB1F1	A13
IO12PB1F1	A12
IO13NB1F1	B13
IO13PB1F1	B12
IO14NB1F1	C12
IO14PB1F1	C11
IO15NB1F1	A15
IO15PB1F1	B14
IO16NB1F1	C15
IO16PB1F1	C14
IO17NB1F1	D13
IO17PB1F1	D12
Bank 2	
IO18NB2F2	F13
IO18PB2F2	E13
IO19NB2F2	F14
IO19PB2F2	E14

FG256-Pin FBGA	
AX125 Function	**Pin Number**
IO20NB2F2	F15
IO20PB2F2	E15
IO21NB2F2	C16
IO21PB2F2	B16
IO22NB2F2	H13
IO22PB2F2	G13
IO23NB2F2	E16
IO23PB2F2	D16
IO25NB2F2	H15
IO25PB2F2	G15
IO26NB2F2	H14
IO26PB2F2	G14
IO27NB2F2	G16
IO27PB2F2	F16
IO28NB2F2	K15
IO28PB2F2	K16
IO29NB2F2	J16
IO29PB2F2	H16
Bank 3	
IO30NB3F3	K13
IO30PB3F3	J13
IO31NB3F3	K14
IO31PB3F3	J14
IO33NB3F3	L15
IO33PB3F3	L16
IO35NB3F3	P16
IO35PB3F3	N16
IO36PB3F3	M16
IO37NB3F3	P15
IO37PB3F3	R16
IO39NB3F3	N15
IO39PB3F3	M15
IO40NB3F3	M13
IO40PB3F3	L13
IO41NB3F3	M14

FG256-Pin FBGA	
AX125 Function	**Pin Number**
IO41PB3F3	L14
Bank 4	
IO42NB4F4	N12
IO42PB4F4	N13
IO43NB4F4	T14
IO43PB4F4	R14
IO44PB4F4	T15
IO45NB4F4	R12
IO45PB4F4	R13
IO46NB4F4	P11
IO46PB4F4	P12
IO47PB4F4	T11
IO48NB4F4	T12
IO48PB4F4	T13
IO49NB4F4/CLKEN	R9
IO49PB4F4/CLKEP	R10
IO50NB4F4/CLKFN	T8
IO50PB4F4/CLKFP	T9
Bank 5	
IO51NB5F5/CLKGN	P7
IO51PB5F5/CLKGP	P8
IO52NB5F5/CLKHN	R6
IO52PB5F5/CLKHP	R7
IO54NB5F5	T5
IO54PB5F5	T6
IO55NB5F5	P5
IO55PB5F5	P6
IO56NB5F5	T3
IO56PB5F5	T4
IO57NB5F5	R3
IO57PB5F5	R4
IO58NB5F5	R1
IO58PB5F5	T2
IO59NB5F5	N4
IO59PB5F5	N5

FG484	
AX250 Function	**Pin Number**
Bank 0	
IO00NB0F0	D7
IO00PB0F0	D6
IO01NB0F0	E7
IO01PB0F0	E6
IO02NB0F0	C5
IO02PB0F0	C4
IO03NB0F0	C7
IO03PB0F0	C6
IO04NB0F0	E9
IO04PB0F0	E8
IO05NB0F0	D9
IO05PB0F0	D8
IO06NB0F0	B7
IO06PB0F0	B6
IO07NB0F0	C9
IO07PB0F0	C8
IO08NB0F0	A7
IO08PB0F0	A6
IO09NB0F0	B9
IO09PB0F0	B8
IO10NB0F0	A9
IO10PB0F0	A8
IO11NB0F0	B10
IO11PB0F0	A10
IO12NB0F0/HCLKAN	E11
IO12PB0F0/HCLKAP	E10
IO13NB0F0/HCLKBN	D12
IO13PB0F0/HCLKBP	D11
Bank 1	
IO14NB1F1/HCLKCN	F13
IO14PB1F1/HCLKCP	F12
IO15NB1F1/HCLKDN	E14
IO15PB1F1/HCLKDP	E13
IO16NB1F1	C13
IO16PB1F1	C12

FG484	
AX250 Function	**Pin Number**
IO17NB1F1	B14
IO17PB1F1	B13
IO18NB1F1	A14
IO18PB1F1	A13
IO19NB1F1	A16
IO19PB1F1	A15
IO20NB1F1	B16
IO20PB1F1	B15
IO21NB1F1	C17
IO21PB1F1	C16
IO22NB1F1	F15
IO22PB1F1	F14
IO23NB1F1	D16
IO23PB1F1	D15
IO24NB1F1	E16
IO24PB1F1	E15
IO25NB1F1	F18
IO25PB1F1	F17
IO26NB1F1	D18
IO26PB1F1	E17
IO27NB1F1	G16
IO27PB1F1	G15
Bank 2	
IO28NB2F2	F19
IO28PB2F2	E19
IO29NB2F2	J16
IO29PB2F2	H16
IO30NB2F2	E20
IO30PB2F2	D20
IO31NB2F2	J17
IO31PB2F2	H17
IO32NB2F2	G20
IO32PB2F2	F20
IO33NB2F2	H19
IO33PB2F2	G19
IO34NB2F2	E22

FG484	
AX250 Function	**Pin Number**
IO34PB2F2	D22
IO35NB2F2	J18
IO35PB2F2	H18
IO36NB2F2	G21
IO36PB2F2	F21
IO37NB2F2	K19
IO37PB2F2	J19
IO38NB2F2	J20
IO38PB2F2	H20
IO39NB2F2	L16
IO39PB2F2	K16
IO40NB2F2	J21
IO40PB2F2	H21
IO41NB2F2	L17
IO41PB2F2	K17
IO42NB2F2	J22
IO42PB2F2	H22
IO43NB2F2	L18
IO43PB2F2	K18
IO44NB2F2	L20
IO44PB2F2	K20
Bank 3	
IO45NB3F3	M19
IO45PB3F3	L19
IO46NB3F3	M21
IO46PB3F3	L21
IO47NB3F3	N17
IO47PB3F3	M17
IO48NB3F3	N18
IO48PB3F3	N19
IO49NB3F3	N16
IO49PB3F3	M16
IO50NB3F3	N20
IO50PB3F3	M20
IO51NB3F3	P21
IO51PB3F3	N21

FG484	
AX1000 Function	**Pin Number**
IO246NB7F22	F3
IO246PB7F22	G3
IO250NB7F23	F4
IO250PB7F23	G4
IO253NB7F23	G5
IO253PB7F23	G6
IO254NB7F23	D1
IO254PB7F23	E1
IO257NB7F23	F5
IO257PB7F23	E4
Dedicated I/O	
VCCDA	H7
GND	A1
GND	A11
GND	A12
GND	A2
GND	A21
GND	A22
GND	AA1
GND	AA2
GND	AA21
GND	AA22
GND	AB1
GND	AB11
GND	AB12
GND	AB2
GND	AB21
GND	AB22
GND	B1
GND	B2
GND	B21
GND	B22
GND	C20
GND	C3
GND	D19

FG484	
AX1000 Function	**Pin Number**
GND	D4
GND	E18
GND	E5
GND	G18
GND	H15
GND	H8
GND	J14
GND	J9
GND	K10
GND	K11
GND	K12
GND	K13
GND	L1
GND	L10
GND	L11
GND	L12
GND	L13
GND	L22
GND	M1
GND	M10
GND	M11
GND	M12
GND	M13
GND	M22
GND	N10
GND	N11
GND	N12
GND	N13
GND	P14
GND	P9
GND	R15
GND	R8
GND	U16
GND	U6
GND	V18

FG484	
AX1000 Function	**Pin Number**
GND	V5
GND	W19
GND	W4
GND	Y20
GND	Y3
GND/LP	G7
PRA	G11
PRB	F11
PRC	T12
PRD	U12
TCK	G8
TDI	F9
TDO	F7
TMS	F6
TRST	F8
VCCA	G17
VCCA	J10
VCCA	J11
VCCA	J12
VCCA	J13
VCCA	J7
VCCA	K14
VCCA	K9
VCCA	L14
VCCA	L9
VCCA	M14
VCCA	M9
VCCA	N14
VCCA	N9
VCCA	P10
VCCA	P11
VCCA	P12
VCCA	P13
VCCA	T6
VCCA	U17

FG896	
AX1000 Function	Pin Number
GND	T12
GND	T13
GND	T14
GND	T15
GND	T16
GND	T17
GND	T18
GND	T19
GND	T28
GND	T3
GND	U12
GND	U13
GND	U14
GND	U15
GND	U16
GND	U17
GND	U18
GND	U19
GND	V1
GND	V12
GND	V13
GND	V14
GND	V15
GND	V16
GND	V17
GND	V18
GND	V19
GND	V30
GND	W12
GND	W13
GND	W14
GND	W15
GND	W16
GND	W17
GND	W18

FG896	
AX1000 Function	Pin Number
GND	W19
GND	Y11
GND	Y20
GND/LP	E4
NC	A16
NC	A26
NC	A4
NC	A6
NC	AA30
NC	AB1
NC	AB30
NC	AC2
NC	AC29
NC	AD1
NC	AD2
NC	AD30
NC	AE1
NC	AE15
NC	AE16
NC	AE2
NC	AE30
NC	AF1
NC	AF2
NC	AF29
NC	AF30
NC	AG1
NC	AG2
NC	AG29
NC	AG30
NC	AH27
NC	AH4
NC	AJ14
NC	AJ15
NC	AJ16
NC	AJ27

FG896	
AX1000 Function	Pin Number
NC	AJ4
NC	AK14
NC	AK15
NC	AK16
NC	AK17
NC	AK22
NC	AK4
NC	AK5
NC	B16
NC	B18
NC	B21
NC	B23
NC	B26
NC	B4
NC	B6
NC	B8
NC	C27
NC	D1
NC	D2
NC	D29
NC	D30
NC	E1
NC	E2
NC	E29
NC	E30
NC	F15
NC	F16
NC	F29
NC	F30
NC	G1
NC	G29
NC	G30
NC	H29
NC	J1
NC	J30

FG1152	
AX2000 Function	Pin Number
GND	AK12
GND	AK17
GND	AK18
GND	AK23
GND	AK30
GND	AK5
GND	AL1
GND	AL11
GND	AL2
GND	AL24
GND	AL3
GND	AL31
GND	AL32
GND	AL33
GND	AL34
GND	AL4
GND	AM1
GND	AM10
GND	AM15
GND	AM2
GND	AM20
GND	AM25
GND	AM3
GND	AM31
GND	AM32
GND	AM33
GND	AM34
GND	AM4
GND	AN1
GND	AN2
GND	AN26
GND	AN3
GND	AN31
GND	AN32
GND	AN33

FG1152	
AX2000 Function	Pin Number
GND	AN34
GND	AN4
GND	AN9
GND	AP13
GND	AP2
GND	AP22
GND	AP27
GND	AP3
GND	AP31
GND	AP32
GND	AP33
GND	AP4
GND	AP8
GND	B1
GND	B2
GND	B26
GND	B3
GND	B31
GND	B32
GND	B33
GND	B34
GND	B4
GND	B9
GND	C1
GND	C10
GND	C15
GND	C2
GND	C20
GND	C25
GND	C3
GND	C31
GND	C32
GND	C33
GND	C34
GND	C4

FG1152	
AX2000 Function	Pin Number
GND	D1
GND	D11
GND	D2
GND	D24
GND	D3
GND	D31
GND	D32
GND	D33
GND	D34
GND	D4
GND	E12
GND	E17
GND	E18
GND	E23
GND	E30
GND	E5
GND	F29
GND	F30
GND	F6
GND	G28
GND	G7
GND	H1
GND	H34
GND	J2
GND	J33
GND	K3
GND	K32
GND	L11
GND	L24
GND	L31
GND	L4
GND	M12
GND	M23
GND	M30
GND	M5

FG1152	
AX2000 Function	Pin Number
NC	AP9
NC	B17
NC	B22
NC	B27
NC	B8
NC	D10
NC	D20
NC	D23
NC	D25
NC	F3
NC	F32
NC	F33
NC	F34
NC	F4
NC	G1
NC	G32
NC	G33
NC	G34
NC	H31
NC	H33
NC	J1
NC	J3
NC	J34
NC	M1
NC	M4
NC	P1
NC	P2
NC	R31
NC	T1
NC	T2
NC	V3
NC	V34
NC	W3
NC	W34
PRA	J17

FG1152	
AX2000 Function	Pin Number
PRB	F18
PRC	AD18
PRD	AH18
TCK	J9
TDI	F7
TDO	L10
TMS	H8
TRST	E6
VCCA	AA13
VCCA	AA22
VCCA	AB14
VCCA	AB15
VCCA	AB16
VCCA	AB17
VCCA	AB18
VCCA	AB19
VCCA	AB20
VCCA	AB21
VCCA	AF8
VCCA	AK28
VCCA	G30
VCCA	G5
VCCA	N14
VCCA	N15
VCCA	N16
VCCA	N17
VCCA	N18
VCCA	N19
VCCA	N20
VCCA	N21
VCCA	P13
VCCA	P22
VCCA	R13
VCCA	R22
VCCA	T13

FG1152	
AX2000 Function	Pin Number
VCCA	T22
VCCA	U13
VCCA	U22
VCCA	V13
VCCA	V22
VCCA	W13
VCCA	W22
VCCA	Y13
VCCA	Y22
VCCDA	AF26
VCCDA	AF9
VCCDA	AG17
VCCDA	AG18
VCCDA	AH14
VCCDA	AH15
VCCDA	AH17
VCCDA	AH20
VCCDA	AH21
VCCDA	AK29
VCCDA	AK6
VCCDA	E15
VCCDA	E29
VCCDA	E7
VCCDA	F15
VCCDA	F21
VCCDA	F5
VCCDA	G20
VCCDA	H17
VCCDA	H18
VCCDA	H28
VCCDA	J18
VCCDA	V27
VCCDA	V6
VCCIB0	A5
VCCIB0	B5

PQ208	
AX250 Function	Pin Number
Bank 0	
IO02NB0F0	197
IO03NB0F0	198
IO03PB0F0	199
IO12NB0F0/HCLKAN	191
IO12PB0F0/HCLKAP	192
IO13NB0F0/HCLKBN	185
IO13PB0F0/HCLKBP	186
Bank 1	
IO14NB1F1/HCLKCN	180
IO14PB1F1/HCLKCP	181
IO15NB1F1/HCLKDN	174
IO15PB1F1/HCLKDP	175
IO16NB1F1	170
IO16PB1F1	171
IO24NB1F1	165
IO24PB1F1	166
IO26NB1F1	161
IO26PB1F1	162
IO27NB1F1	159
IO27PB1F1	160
Bank 2	
IO29NB2F2	151
IO29PB2F2	153
IO30NB2F2	152
IO30PB2F2	154
IO31PB2F2	148
IO32NB2F2	146
IO32PB2F2	147
IO34NB2F2	144
IO34PB2F2	145
IO39NB2F2	139
IO39PB2F2	140
IO40PB2F2	141
IO41NB2F2	137
IO41PB2F2	138
IO43NB2F2	132

PQ208	
AX250 Function	Pin Number
IO43PB2F2	134
IO44NB2F2	131
IO44PB2F2	133
Bank 3	
IO45NB3F3	127
IO45PB3F3	129
IO46NB3F3	126
IO46PB3F3	128
IO48NB3F3	122
IO48PB3F3	123
IO50NB3F3	120
IO50PB3F3	121
IO55NB3F3	116
IO55PB3F3	117
IO57NB3F3	114
IO57PB3F3	115
IO59NB3F3	110
IO59PB3F3	111
IO60NB3F3	108
IO60PB3F3	109
IO61NB3F3	106
IO61PB3F3	107
Bank 4	
IO62NB4F4	100
IO62PB4F4	103
IO63NB4F4	101
IO63PB4F4	102
IO64NB4F4	96
IO64PB4F4	97
IO72NB4F4	91
IO72PB4F4	92
IO74NB4F4/CLKEN	87
IO74PB4F4/CLKEP	88
IO75NB4F4/CLKFN	81
IO75PB4F4/CLKFP	82
Bank 5	
IO76NB5F5/CLKGN	76

PQ208	
AX250 Function	Pin Number
IO76PB5F5/CLKGP	77
IO77NB5F5/CLKHN	70
IO77PB5F5/CLKHP	71
IO78NB5F5	66
IO78PB5F5	67
IO86NB5F5	62
IO87NB5F5	60
IO87PB5F5	61
IO88NB5F5	56
IO88PB5F5	57
IO89NB5F5	54
IO89PB5F5	55
Bank 6	
IO91NB6F6	47
IO91PB6F6	49
IO92NB6F6	48
IO92PB6F6	50
IO93NB6F6	42
IO93PB6F6	43
IO94PB6F6	44
IO96NB6F6	40
IO96PB6F6	41
IO101NB6F6	35
IO101PB6F6	36
IO102PB6F6	37
IO103NB6F6	33
IO103PB6F6	34
IO105NB6F6	28
IO105PB6F6	30
IO106NB6F6	27
IO106PB6F6	29
Bank 7	
IO107NB7F7	23
IO107PB7F7	25
IO108NB7F7	22
IO108PB7F7	24
IO110NB7F7	18

CQ352	
AX500 Function	Pin Number
VCCDA	346
VCCIB0	321
VCCIB0	333
VCCIB0	344
VCCIB1	273
VCCIB1	285
VCCIB1	297
VCCIB2	227
VCCIB2	239
VCCIB2	245
VCCIB2	257
VCCIB3	185
VCCIB3	197
VCCIB3	203
VCCIB3	215
VCCIB4	144
VCCIB4	156
VCCIB4	168
VCCIB5	96
VCCIB5	108
VCCIB5	120
VCCIB6	50
VCCIB6	62
VCCIB6	68
VCCIB6	80
VCCIB7	8
VCCIB7	20
VCCIB7	26
VCCIB7	38
VCCPLA	317
VCCPLB	315
VCCPLC	303
VCCPLD	301
VCCPLE	140
VCCPLF	138

CQ352	
AX500 Function	Pin Number
VCCPLG	126
VCCPLH	124
VCOMPLA	318
VCOMPLB	316
VCOMPLC	304
VCOMPLD	302
VCOMPLE	141
VCOMPLF	139
VCOMPLG	127
VCOMPLH	125
VPUMP	267

CG624	
AX2000 Function	**Pin Number**
IO157PB3F14	U20
IO158NB3F14	AB25
IO158PB3F14	AA25
IO160PB3F14	W24
IO161NB3F15	U24
IO161PB3F15	U23
IO162NB3F15	AA24
IO162PB3F15	Y24
IO163NB3F15	V22
IO163PB3F15	U22
IO164NB3F15	V23
IO164PB3F15	V24
IO166NB3F15	AB24
IO167NB3F15	V21
IO167PB3F15	U21
IO168NB3F15	Y23
IO168PB3F15	AA23
IO169NB3F15	W22*
IO169PB3F15	W23*
IO170NB3F15	Y22
IO170PB3F15	Y21
Bank 4	
IO171NB4F16	AC20*
IO171PB4F16	AC21*
IO172NB4F16	W20
IO172PB4F16	Y20
IO173NB4F16	AD21
IO173PB4F16	AD22
IO174NB4F16	AA19
IO176NB4F16	Y18
IO176PB4F16	Y19
IO177NB4F16	AB19

*Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.*

CG624	
AX2000 Function	**Pin Number**
IO177PB4F16	AB18
IO182NB4F17	V19
IO182PB4F17	W19
IO183PB4F17	AC19
IO184NB4F17	AB17
IO184PB4F17	AC17
IO185NB4F17	AD19
IO185PB4F17	AD20
IO187PB4F17	AC18
IO188NB4F17	Y17
IO188PB4F17	AA17
IO189PB4F17	AE22
IO191NB4F17	W18
IO191PB4F17	V18
IO192PB4F17	U18
IO195PB4F18	AE21
IO196NB4F18	AB16
IO197NB4F18	AD17
IO197PB4F18	AD18
IO198NB4F18	V17
IO198PB4F18	W17
IO199NB4F18	AE19
IO199PB4F18	AE20
IO200NB4F18	AC15
IO201NB4F18	AD15
IO201PB4F18	AD16
IO202NB4F18	Y15
IO202PB4F18	Y16
IO206NB4F19	AB14
IO206PB4F19	AB15
IO207NB4F19	AE15
IO207PB4F19	AE16

*Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.*

CG624	
AX2000 Function	**Pin Number**
IO208PB4F19	W16
IO209NB4F19	AE14
IO210NB4F19	V15
IO210PB4F19	V16
IO211NB4F19	AD14
IO211PB4F19	AC14
IO212NB4F19/CLKEN	W14
IO212PB4F19/CLKEP	W15
IO213NB4F19/CLKFN	AC13
IO213PB4F19/CLKFP	AD13
Bank 5	
IO214NB5F20/CLKGN	W13
IO214PB5F20/CLKGP	Y13
IO215NB5F20/CLKHN	AC12
IO215PB5F20/CLKHP	AD12
IO216NB5F20	U13
IO216PB5F20	V13
IO217NB5F20	AE10
IO217PB5F20	AE11
IO218NB5F20	W11
IO218PB5F20	W12
IO222NB5F20	AA11
IO222PB5F20	Y11
IO223PB5F21	AE9
IO225NB5F21	AE6
IO225PB5F21	AE7
IO226NB5F21	Y10
IO226PB5F21	W10
IO227PB5F21	T13
IO228NB5F21	AB10
IO228PB5F21	AB11
IO229NB5F21	AD9

*Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.*

Datasheet Categories

Categories

In order to provide the latest information to designers, some datasheet parameters are published before data has been fully characterized from silicon devices. The data provided for a given device, as highlighted in the "Axcelerator Family Device Status" table on page iii, is designated as either "Product Brief," "Advance," "Preliminary," or "Production." The definitions of these categories are as follows:

Product Brief

The product brief is a summarized version of a datasheet (advance or production) and contains general product information. This document gives an overview of specific device and family information.

Advance

This version contains initial estimated information based on simulation, other products, devices, or speed grades. This information can be used as estimates, but not for production. This label only applies to the DC and Switching Characteristics chapter of the datasheet and will only be used when the data has not been fully characterized.

Preliminary

The datasheet contains information based on simulation and/or initial characterization. The information is believed to be correct, but changes are possible.

Production

This version contains information that is considered to be final.

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